12/16/2011 Form PTO-1595 (Rev. 03-11) OMB No. 0651-0027 (exp. 03) MENT OF COMMERCE ant and Trademark Office 103638034 PAI To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below. 2. Name and address of receiving party(ies) 1. Name of conveying party(ies): Junichi Yamashita (10/26/2011) and Katsuhide Sony Corporation Uchino (10/31/2011) Internal Address: Additional name(s) of conveying party(ies) attached? Street Address: 3. Nature of conveyance/Exécution Date(s): 1-7-1 Konan Minato-Ku, Tokyo Execution Date(s): in parentheses after inventor name 108-0075 **JAPAN** x Assignment Merger Change of Name Joint Research Agreement Security Agreement Government Interest Assignment State: Executive Order 9424, Confirmatory License Country: Additional name(s) & address(es) Yes attached? x This document is being filed together with a new application. 4. Application or patent number(s): A. Patent Application No.(s) B. Patent No.(s) 13/323,380 Additional numbers attached? 5. Name and address to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: Christopher M. Tobin 40.00 RADER, FISHMAN & GRAUER PLLC 7. Total fee (37 CFR 1.21(h) & 3.41) . \$ Internal Address: Atty. Dkt.: SON-4942 Street Address: 1233 20th Street, N.W. Authorized to be charged to deposit account Suite 501 Enclosed None required (government interest not affecting title) Washington City: 8. Payment Information DC 20036

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Fax Number:

Email Address: 9. Signature:

PATENT

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Christopher M. Tobin

December 14, 2011

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Total กิษฏิเอา of pages including cover sheet, attachments, and documents.

Attorney Docket No. 80001-4942 SONY Ref. No.: S11P2131US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SIGNAL PROCESSING DEVICE, SIGNAL PROCESSING METHOD, DISPLAY DEVICE, AND ELECTRONIC

APPARATUS

RECORDED: 12/14/2011

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application has been been determined as $\frac{13/323,380}{12-12-261}$.	
This assignment executed on the dates indicated below.	
JUNICHI YAMASHITA	
Name of first or sole inventor TOKYO JAPAN	Execution date of U.S. Patent Application
Residence of First or sole inventor	Oct 26 20/1
Signature of first or sole inventor	Date of this assignment
KATSUHIDE UCHINO	
Name of second inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application
Residence of second inventor	DC 11, 201/
Signature of second inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment

PATENT REEL: 027497 FRAME: 0730